Description

The IRF740PBF uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

G D S

TO-220 (TO-220AB)

General Features

V_{DS} =420V,I_D =11A

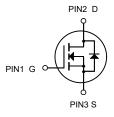
 $R_{DS(ON)} < 0.5 \Omega$ @ $V_{GS}=10V$

Application

High efficiency switch mode power supplies

Power factor correction

Electronic lamp ballast



N-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Marking	Units Tube
IRF740PBF	TO-220(TO-220AB)	IRF740 XXXX	50

Absolute Maximum Ratings@T_j=25 °C(unless otherwise specified)

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage	420	V
VGS	Gate-Source Voltage	<u>+</u> 30	V
I _D @T _C =25°C	Drain Current, V _{GS} @ 4.5V	11	Α
IDM	Pulsed Drain Current ¹	44	Α
P _D @T _C =25°C	Total Power Dissipation	87	W
TSTG	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C



Electrical Characteristics (T_C=25°C, unless otherwise specified)

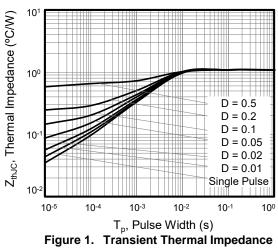
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Off Characteristics	•	•				
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	420			V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =650V, V _{GS} =0V			1	μΑ
Gate- Source Leakage Current Forward Reverse	I _{GSS}	V _{G=} 30V, V _{DS} = 0V V _{GS} =-30V, V _{DS} =0V			100 -100	nA nA
On Characteristics	•	, 55	J.			
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$	2.0		4.0	V
Static Drain-Source On-State Resistance	R _{DS(ON)}	V_{GS} =10V, I_D =1A		0.36	0.5	Ω
D namic Characteristics						
Input Capacitance	C _{ISS}			1368		pF
Output Capacitance	Coss	V _{DS} =25V, V _{GS} =0V, f=1.0 MHz		90.3		рF
Reverse Transfer Capacitance	C_{RSS}			3		рF
Switching Characteristics						
Turn-On Delay Time	t _{D(ON)}	V _{DD} =250V, I _D =10A,		16		ns
Turn-On Rise Time	t _R			25		ns
Turn-Off Delay Time	t _{D(OFF)}	R _G =25Ω (Note 1, 2)		40		ns
Turn-Off Fall Time	t _F			29		ns
Total Gate Charge	Q_G	V _{DS} =480V, I _D =12A,		8.1		nC
Gate-Source Charge	Q_GS	V _{GS} =10V (Note 1, 2)		7.4		nC
Gate-Drain Charge	Q_GD	VGS 10 V (14010 1, 2)		5		nC
Drain-Source Diode Characteristics And I	/laximum Rati	ngs				
Drain-Source Diode Forward Voltage	V_{SD}	$V_{GS} = 0 V, I_{S} = 11A$			1.2	V
Maximum Continuous Drain-Source Diode Forward Current	Is				11	Α
Maximum Pulsed Drain-Source Diode Forward Current	I _{SM}				44	Α
Reverse Recovery Time	t _{rr}	V _{GS} =0V, I _S =12A,		435		ns
Reverse Recovery Charge	Q _{RR}	dl _F /dt =100 A/μs (Note 1)		4		μC

Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%.

^{2.} Essentially independent of operating temperature.



Typical Characteristics:



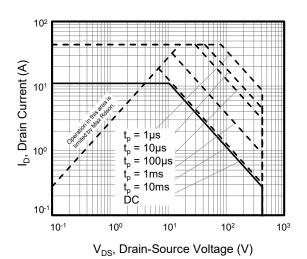


Figure 2. Safe Operation Area

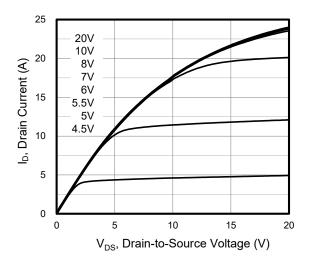


Figure 3. Output Characteristics

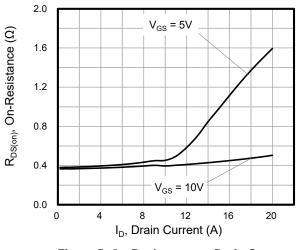


Figure 5. On-Resistance vs Drain Current

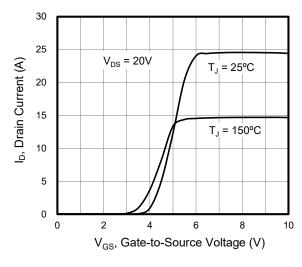


Figure 4. Transfer Characteristics

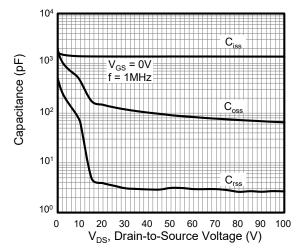
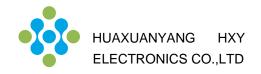
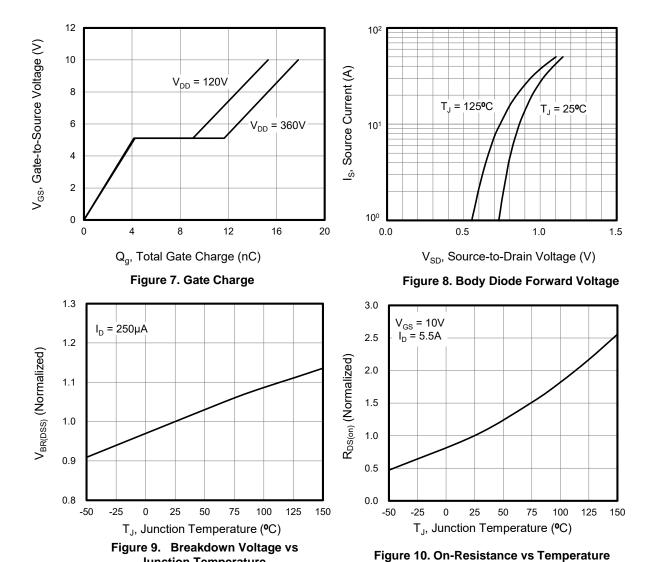


Figure 6. Capacitance



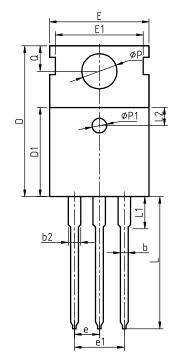


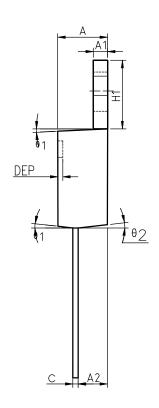
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Junction Temperature

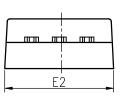


Package Information TO-220(TO-220AB)





COMMON DIMENSIONS



SYMBOL	MIN	NOM	MAX	MIN	NOM	MAX
Α	4.40	4.57	4.70	0.173	0.180	0.185
A1	1. 27	1.30	1.33	0.050	0.051	0.052
A2	2. 35	2.40	2.50	0.093	0.094	0.098
b	0.77	0.80	0.90	0.030	0.031	0.035
b2	1. 17	1. 27	1.36	0.046	0.050	0.054
С	0.48	0.50	0.56	0.019	0.020	0.022
D	15.40	15.60	15.80	0.606	0.614	0.622
D1	9.00	9. 10	9.20	0.354	0.358	0.362
DEP	0.05	0.10	0.20	0.002	0.004	0.008
E	9.80	10.00	10.20	0.386	0.394	0.402
E1	ı	8.70	ı	-	0.343	-
E2	9.80	10.00	10.20	0.386	0.394	0.402
е		2.54	BSC		0.100	BSC
e1		5.08	BSC		0.200	BSC
H1	6.40	6.50	6.60	0. 252	0.256	0.260
L	12.75	13.50	13.65	0.502	0.531	0.537
L1	-	3.10	3.30	-	0.122	0.130
L2		2.50	REF		0.098	REF
Р	3.50	3.60	3.63	0.138	0.142	0.143
P1	3.50	3.60	3.63	0.138	0.142	0.143
Q	2.73	2.80	2.87	0.107	0.110	0. 113
θ 1	5°	7°	9°	5°	7°	9°
θ 2	1°	3°	5°	1°	3°	5°
θ 3	1°	3°	5°	1°	3°	5°



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